TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

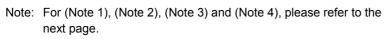
# **TPC8003**

Lithium Ion Battery Applications Portable Equipment Applications Notebook PC Applications

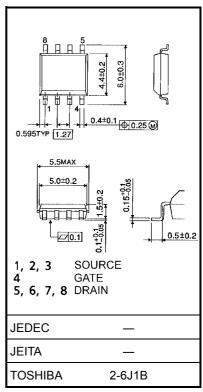
- Small footprint due to small and thin package
- Low drain-source ON resistance  $: R_{DS} (ON) = 5.4 \text{ m}\Omega (typ.)$
- High forward transfer admittance :  $|Y_{fs}| = 21 \text{ S (typ.)}$
- Low leakage current  $: I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement-mode :  $V_{th} = 0.8 \sim 2.5 \text{ V} (V_{DS} = 10 \text{ V}, \text{ ID} = 1 \text{ mA})$

#### Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	30	V	
Drain-gate voltage (R	R <sub>GS</sub> = 20 kΩ)	V <sub>DGR</sub>	30	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC (Note 1)	I <sub>D</sub>	13	А	
	Pulse (Note 1)	I <sub>DP</sub>	52	~	
Drain power dissipati	on (t = 10 s) (Note 2a)	PD	2.4	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	PD	1.0	W	
Single pulse avalancl	ne energy (Note 3)	E <sub>AS</sub>	220	mJ	
Avalanche current		I <sub>AR</sub>	13	А	
Repetitive avalanche	energy Note 2a) (Note 4)	E <sub>AR</sub>	0.24	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature	range	T <sub>stg</sub>	−55 to 150	°C	

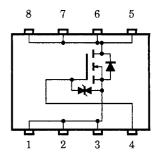


This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 0.080 g (typ.)

#### **Circuit Configuration**

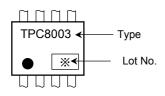


Unit: mm

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	52.1	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W

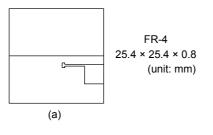
#### Marking (Note 5)

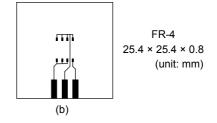


Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)





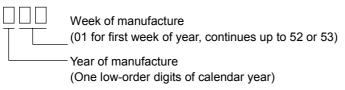


Note 3: V\_DD = 24 V, T\_ch = 25 °C (initial), L = 1.0 mH, R\_G = 25  $\Omega$ , I<sub>AR</sub> = 13 A

Note 4: Reptitve rating; pulse width limited by maximum channel temperature

Note 5:  $\bullet$  on lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)

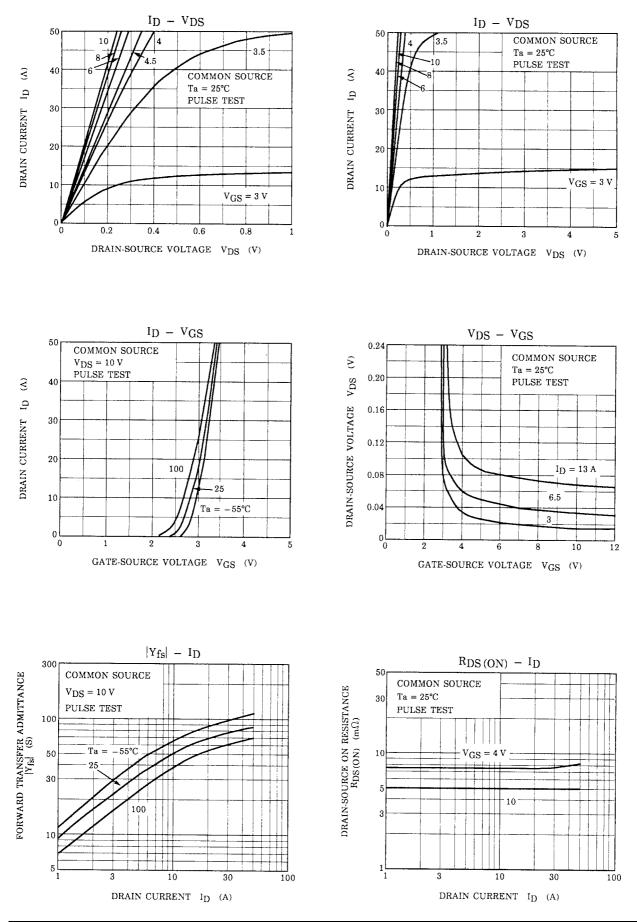


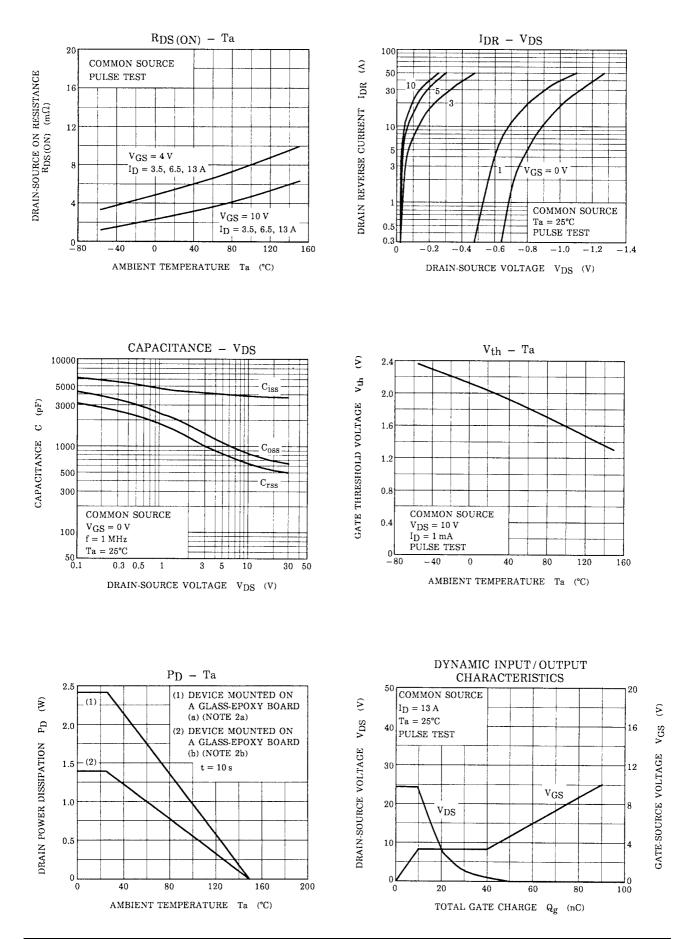
#### Electrical Characteristics (Ta = 25°C)

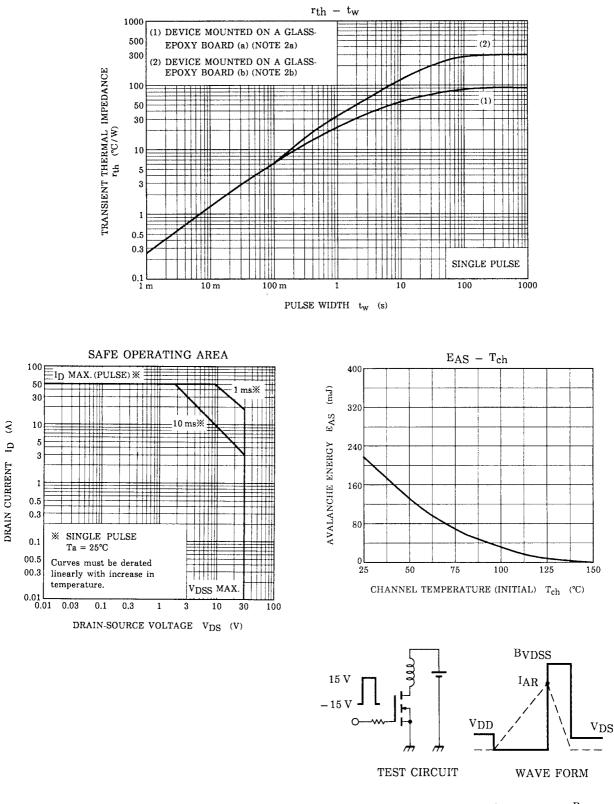
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I <sub>GSS</sub>	$V_{GS}$ = ±16 V, $V_{DS}$ = 0 V		_	±10	μA
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V -			10	μA
Drain-source breakdown voltage		V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	30	—	—	V
		V (BR) DSX	$I_{D}$ = 10 mA, $V_{GS}$ = -20 V	15	-	_	V
Gate threshold v	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	0.8	_	2.5	V
Drain-source ON resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = 4 V, I <sub>D</sub> = 6.5 A		8.3	13	mΩ
		R <sub>DS (ON)</sub>	$V_{GS}$ = 10 V, I <sub>D</sub> = 6.5 A		5.4	7	mΩ
Forward transfer	r admittance	Y <sub>fs</sub>	Y <sub>fs</sub>   V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A		21	_	S
Input capacitance		C <sub>iss</sub>			4380	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		500	_	pF
Output capacitance		C <sub>oss</sub>			890		
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{_{0 \text{ V}}} \prod_{\substack{\mathbf{O} \\ \mathbf{C} \\$	_	14	_	
	Turn-on time	t <sub>on</sub>		_	27	_	
	Fall time	t <sub>f</sub>		_	72	_	ns
	Turn-off time	t <sub>off</sub>		_	235	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	90	_	
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ 24 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13 A		60	_	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>		—	30	—	

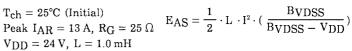
#### Source–Drain Ratings and Characteristics (Ta = 25°C)

Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I <sub>DRP</sub>	—	Ι	_	52	А
Forward voltage	(diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_		-1.2	V









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